IRSF3010

FULLY PROTECTED POWER MOSFET SWITCH

General Description:

The IRSF3010 is a three terminal monolithic SMART POWER MOSFET with built in short circuit, over-temperature, ESD and over-voltage protections.

The on chip protection circuit latches off the POWER MOSFET in case the drain current exceeds 14A (typical) or the junction temperature exceeds 165°C (typical) and keeps it off until the input is driven low. The drain to source voltage is actively clamped at 55V (typical), prior to the avalanche of POWER MOSFET, thus improving its performance during turn off with inductive loads.

The input current requirements are very low (300uA) which makes the IRSF3010 compatible with most existing designs based on standard POWER MOSFETs.

Applications:

- DC Motor Drive
- Solenoid Driver

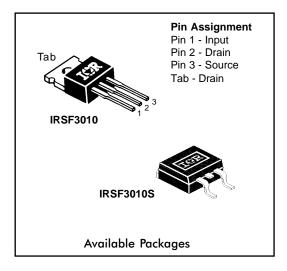
Input	Bias Supply VRef VRef Tj
	IRSF3010 - Block Diagram

Rating Summary:

V ds(clamp)	50 V
R _{ds(on)}	80 m Ω
ds(sd)	11 A
$\mathbf{T}_{j(sd)}$	155 °C
E _{AS}	400 mJ

Features:

- Extremely Rugged for Harsh Operating Environments
- Over Temperature Protection
- Over Current Protection
- Active Drain to Source Clamp
- ESD Protection
- Compatible with standard POWER MOSFET
- Low Operating Input Current
- Monolithic Construction
- Dual set/reset Threshold Input



Absolute Maximum Ratings

Absolute Maximum Ratings indicate sustained limits beyond which damage to the device may occur. ($T_C = 25^{\circ}C$ unless otherwise specified.)

Symbol	Parameter Definition	Min.	Max.	Units	Test Conditions
V _{ds, max}	Continuous Drain to Source Voltage	_	50	V	
Vin, max	Continuous Input Voltage	-0.3	10	V	
Ids	Continuous Drain Current	_	self limited	9	
Pd	Power Dissipation	_	40	W	T _C ≤25°C
	Linear Derating Factor for Tc > 25°C	_	0.33	W/°C	
EAS	Unclamped Single Pulse Inductive Energy	_	400	mJ	
Vesd1	Electrostatic Discharge Voltage (Human Body Model)	_	4000	V	1000pF. 1.5kΩ
V _{esd2}	(Machine Model)	_	1000		200pF, 0Ω
T _{Jop}	Junction Temperature	-55	self-limited		
T _{Stg}	Storage Temperature	-55	175	°C	
TL	Lead Temperature (Soldering, 10 seconds)	_	300		

Static Electrical Characteristics

 $(T_C = 25^{\circ}C \text{ unless otherwise specified.})$

Symbol	Parameter Definition	Min.	Тур.	Max.	Units	Test Conditions
Vds,clamp	Drain to Source Clamp Voltage	50	54	_	V	I _{dS} = 10mA
		_	56	62	. •	$I_{dS} = 11A, t_p = 700 \mu S$
R _{ds(on)}	Drain to Source On Resistance	_	70	80		$V_{in} = 5V$, $I_{dS} = 4A$
		_	85	_	mΩ	V _{in} = 4V, I _{dS} = 4A
		_	53	_		V _{in} = 10V, I _{ds} = 4A
I _{dss}	Drain to Source Leakage Current	_	_	10	μΑ	V _{ds} = 12V, V _{in} = 0V
		_	_	100		V _{ds} = 50V, V _{in} = 0V
		_	10	250		V _{ds} =40V,V _{in} =0V,T _c =150°C
V _{th}	Input Threshold Voltage	1.5	2.0	2.5	V	$V_{dS} = 5V$, $I_{dS} = 1mA$
li, on	Input Supply Current (Normal Operation)	_	0.25	0.6		V _{in} = 5V
		_	0.35	0.85	mA	V _{in} = 10V
li, off	Input Supply Current (Protection Mode)	<u> </u>	0.5	1.0	1117	V _{in} = 5V
		_	0.6	1.2		V _{in} = 10V
Vin, clamp	Input Clamp Voltage	10	10.8	_	V	l _{in} = 10mA
V _{sd}	Body-Drain Diode Forward Drop ②		1.2	1.5	· v	I_{ds} = -17A, R_{in} = 1k Ω

Thermal Characteristics

Symbol	Parameter Definition	Min.	Тур.	Max.	Units	Test Conditions
R⊝jc	Thermal Resistance, Junction to Case	_	3.0	_	°C/W	
R⊝jA	Thermal Resistance, Junction to Ambient	_	60	_	°C/W	

Switching Electrical Characteristics:

 $(V_{CC} = 14V, Resistive Load R_L = 5\Omega, T_C = 25 °C.)$ Please refer to Figure 15 for switching time definitions.

Symbol	Parameter Definition	Min.	Тур.	Max.	Units	Test Conditions
^t don	Turn-On Delay time	_	425	650		V _{in} = 5V
		_	150	_		V _{in} = 10V
t _r	Rise Time	_	2000	4000		V _{in} = 5V
		_	425	_	nS	V _{in} = 10V
tdoff	Turn-Off Delay time	_	650	1000	113	V _{in} = 5V
		_	850	_		V _{in} = 10V
tf	Fall Time	_	500	800	1	V _{in} = 5V
		_	450	_		V _{in} = 10V

Protection Characteristics:

(T_C = 25 °C unless otherwise specified.)

Symbol	Parameter Definition	Min.	Тур.	Max.	Units	Test Conditions
lds(sd)	Over-Current Shutdown Threshold	11	14	17	Α	Vin = 5V
Tj(sd)	Over Temperature Shutdown Threshold	155	165	_	°C	V _{in} = 5V, Ids = 2A
Vprotect	Minimum Input Voltage for Over-temp fxn.	_	3	_	V	
tlresp	Over Current Response Time	_	2	_	C	See figure 16 for definition
tlblank	Over Current Blanking Time	_	3	_	μS	See figure 16 for definition
I _{peak}	Peak Short Circuit Current	_	20	_	Α	See figure 16 for definition
V _{reset}	Protection Reset Voltage	_	1.3	_	V	
treset	Protection Reset Time	_	7	_		See figure 17 for definition
tTresp	OverTemperature Response Time	_	12	_	μS	See figure 18 for definition

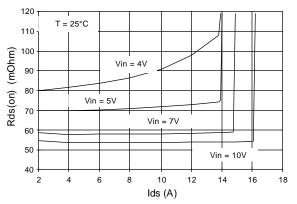
Temperature Coefficients of Electrical Characteristics:

(Please see Figures 3 through 14 for more data on thermal characteristics of other electrical parameters.

Symbol	Parameter Definition	Min.	Тур.	Max.	Units	Test Conditions
V _{ds,clamp}	Temperature Coefficient of Drain to Source					
	Clamp Voltage	—	18.2	_		$I_{ds} = 10mA$
V _{th}	Temperature Coefficient of Input Threshold				mV/ºC	
	Voltage	_	-3.2	_	11107 C	$V_{dS} = 5V$, $I_{dS} = 1mA$
Vin,clamp	Temperature Coefficient of Input Clamp					
	Voltage	 —	7.0	_		$I_{in} = 10mA$
lds(sd)	Temperature Coefficient of Over-Current					
	Shutdown Threshold	_	-21.5	_	mA/oC	$V_{in} = 5V$

Notes:

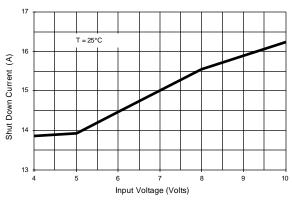
- 1. EAS is tested with a constant current source of 11A applied for $700\mu S$ with $V_{in} = OV$ and starting $T_i = 25^{\circ}C$.
- 2. Input current must be limited to less than 5mA with a 1kΩ resistor in series with the input when the Body-Drain Diode is forward biased.



120 Ids = 4A110 100 Rds(on) (mOhm) 90 Vin = 5V 80 70 60 50 Vin = 10V 40 30 -50 -25 75 100 125 150 Temperature (°C)

Fig. 3 - On Resistance vs Drain to Source Current

Fig. 4 - On Resistance vs. Temperature



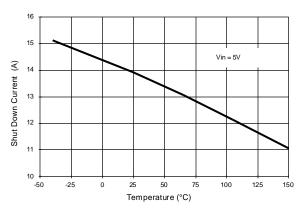
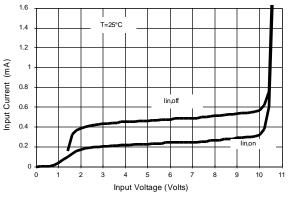


Fig. 5 - Over-current Shutdown Threshold vs Input Voltage

Fig. 6 - Over-current Shutdown Threshold vs
Temperature



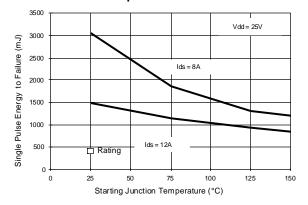


Figure 7 - Input Current vs. Input Voltage

Fig. 8 - Unclamped Single Pulse Inductive Energy to Failure vs Starting Junction Temperature

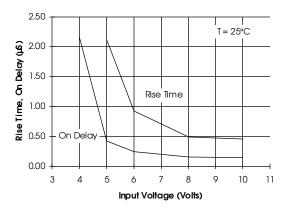


Fig. 9 - Turn on characteristics vs Input Voltage

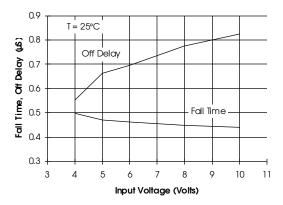


Fig. 11 - Turn off characteristics vs Input Voltage

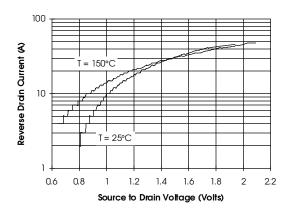


Fig. 13 - Source-Drain Diode Forward Voltage

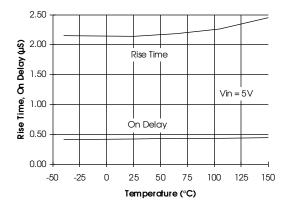


Fig. 10 - Turn on characteristics vs Temperature

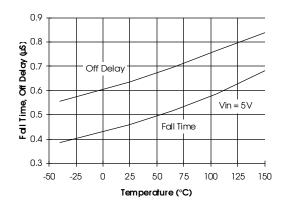


Fig. 12 - Turn off characteristics vs Temperature

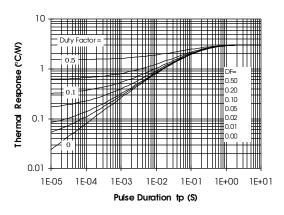


Fig. 14 - Transient Thermal Impedance, Junction to Case

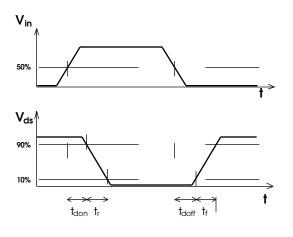


Fig. 15 - Definition of Switching times.

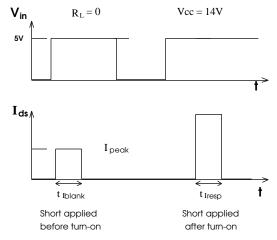


Fig. 16 - Definition of Ipeak, tlblank, tlresp

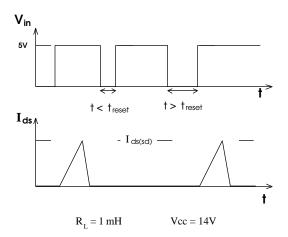


Fig. 17 - Definition of treset

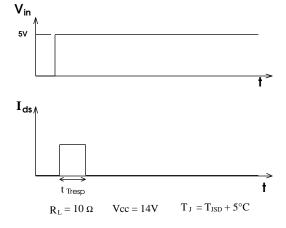
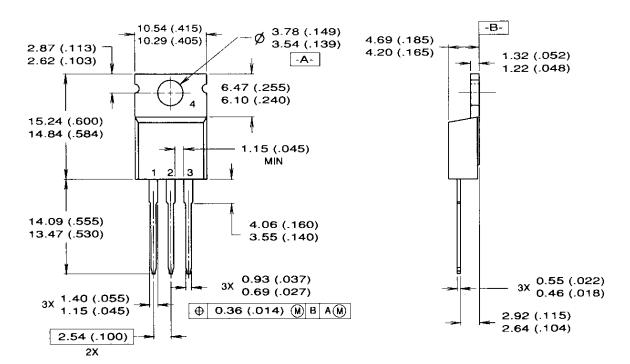


Fig. 18 - Definition of t_{Tresp}

Case Outline — TO-220AB (IRSF3010)



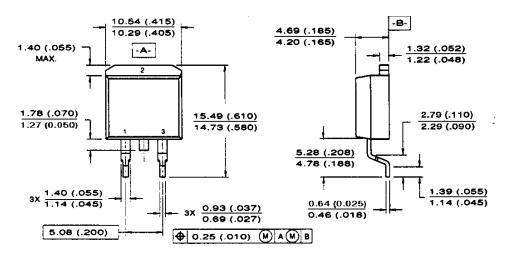
NOTES:

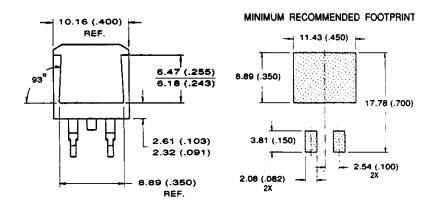
- 1. Dimensioning and tolerancing per ANSI Y14.5M, 1982
- 2. Controlling dimension: INCH
- 3. Dimensions shown are in millimeters (inches)
- 4. Conforms to JEDEC outline TO-251AA
- Dimension does not include solder dip. Solder dip max. +0.16 (.006)

LEAD ASSIGNMENTS

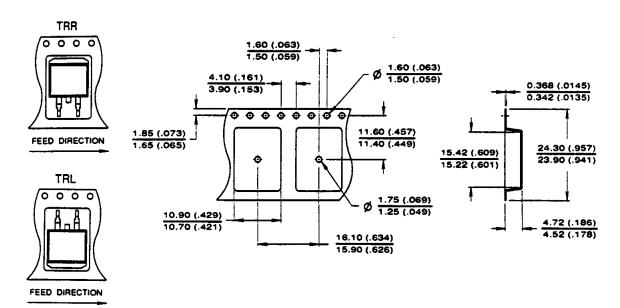
- 1. Gate
- 2. Drain
- 3. Source
- 4. Drain

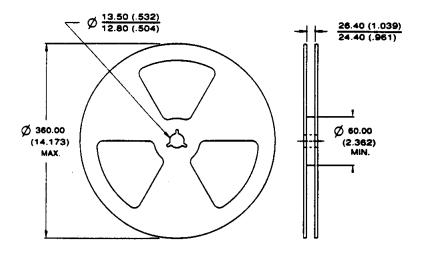
Case Outline — SMD-220 (IRSF3010S)





Tape and Reel — SMD-220 (IRSF3010S)





Application Information

Introduction

Protected monolithic POWER MOSFETs offer simple, cost effective solutions in applications where extreme operating conditions can occur. The margin between the operating conditions and the absolute maximum values can be narrowed resulting in better utilization of the device and lower cost. ESD protection also reduces the off-circuit failures during handling and assembly.

General Description

The IRSF3010 is a fully protected monolithic N-channel, logic level POWER MOSFET with $80m\Omega$ (max) on-resistance. The built-in protections include overcurrent, over-temperature, ESD and active over-voltage protections.

The over-current and over-temperature protection makes the IRSF3010 indestructible at any load conditions in switching or in linear applications. The built-in ESD protection minimizes the risk of ESD damage when the device is off-circuit. The IRSF3010 is fully characterized for avalanche operation and can be used for fast de-energization of inductive loads.

The IRSF3010 Intelligent Power Switch that is available in the TO220 package offers an easy upgrade from non-protected devices.

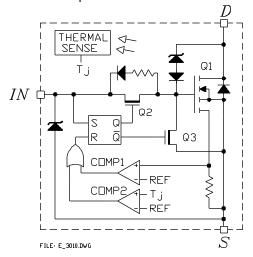


Fig.20 Block Diagram

Block Diagram

The zener diode between the input and the source (see figure 20) provides the ESD protection for the input and also limits the applicable voltage to the input to 10V.

The R-S flip-flop memorizes the occurrence of an error condition and controls the Q2 and Q3 switches. The flip-flop can be cleared by holding the input low for the specified minimum duration.

COMP1 and COMP2 comparators are used to compare the over-current and over-temperature signals with the built-in reference. Either comparator can reset the fault flip-flop and turn Q1 off. During fault condition, Q2 disconnects gate of Q1 from the input, Q3 shorts the gate and source of Q1, resulting in rapid turn-off of Q1. The zener diode between the gate and drain of Q1 turns Q1 on, when the drain to source voltage exceeds 55V.

Switching Characteristics

In the IRSF3010 the control logic and the protection circuits are powered from the input pin. When positive voltage appears at the input pin the R-S flip-flop turns Q2 on and connects the gate of the main device to the input.

The turn-on speed is limited by the channel resistance of Q2 and the gate charge requirements of Q1. The typical switching waveforms at 5V input voltage are shown in figure 21. Using higher input voltage will improve the turn-on time but it does not affect the turn-off switching speed.

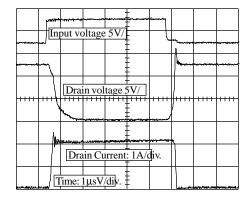


Fig.21 Waveforms switching clamped indictive load using 5V input voltage

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The typical waveforms at 7V input voltage are shown in figure 22. In typical switching applications, below 40kHz, the difference in switching losses between the IRSF3010 and the same size standard MOSFET is negligible.

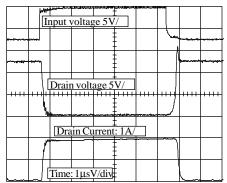


Fig. 22 Switching waveforms with 7V Input voltage

Over-current Protection

When the drain current exceeds the preset limit the protection circuit resets the internal flip-flop and turns Q1 off. The normal operation can be restored by holding the input voltage below the specified threshold level (approx. 1.3V) for the specified minimum treset time.

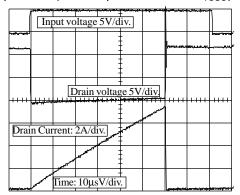


Fig. 23 Waveforms at over-current shut-down

The typical waveforms at over-current shut-down are shown in figure 23. After turn-on the current in the inductor at the drain starts ramping up. At about 15A the over-current protection shuts down the device.

Over-temperature Protection

Figure 24 illustrates the operation of the over-temperature protection. The IRSF3010 switches a 1Ω resistive load to a 12V power supply. When the thermal balance is established the junction temperature is limited on pulse by pulse basis.

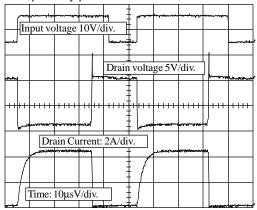


Fig. 24 Over-temperature shut-down

Over-voltage Protection

When the drain to source voltage exceeds 55V the zener diode between gate and drain turns the IRSF3010 on, before the breakdown voltage of the drain-source diode is reached. This greatly enhances the energy the device can withstand safely during turnoff of inductive loads compared to avalanche breakdown. Thus the device can be used for fast deenergization of inductive loads. The absorbed energy is limited only by the maximum junction temperature.

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